

TOPAZ
SEMICONDUCTOR

**VN10LM,
VN222LM**

**N-CHANNEL ENHANCEMENT-MODE
D-MOS POWER FETs**

ORDERING INFORMATION

TO-237 Plastic Package	VN10LM	VN222LM
Description	60V, 5 ohm	60V, 7.5 ohm

FEATURES

- High Gate Oxide Breakdown, $\pm 40V$ min.
- Low Output and Transfer Capacitances
- Extended Safe Operating Area

APPLICATIONS

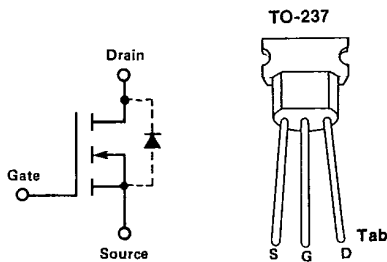
- High-Speed Pulse Amplifiers
- Logic Buffers
- Line Drivers
- Solid-State Relays
- Motor Controls
- Power Supplies

ABSOLUTE MAXIMUM RATINGS ($T_A = +25^\circ C$ unless otherwise noted)

Drain-Source Voltage	+60V	
Drain-Gate Voltage ($V_{GS} = 0$)	+60V	
Gate-Source Voltage	± 40	
Continuous Drain Current	$T_A = 25^\circ C$	$T_C = 25^\circ C$
VN10LM	.19A	.44A
VN222LM	.16A	.36A
Peak Pulsed Drain Current	1.0A	

Continuous Device Dissipation	$T_A = +25^\circ C$	$T_C = +25^\circ C$	
	0.36	1.8	W
Linear Derating Factor	$T_A = +25^\circ C$	$T_C = +25^\circ C$	
	2.9	14.4	mW/ $^\circ C$
Operating Junction Temperature Range	-55 to +150 $^\circ C$		
Storage Temperature Range	-55 to +150 $^\circ C$		
Lead Temperature (1/16" from mounting surface for 30 Sec)	+260 $^\circ C$		

SCHEMATIC DIAGRAM/PACKAGE



PACKAGE DIMENSIONS

TO-237
(See Package 7)



T-29-25
VN10LM, VN222LM

ELECTRICAL CHARACTERISTICS (T_A = +25°C unless otherwise noted)

#	CHARACTERISTIC	VN10LM			VN222LM			UNIT	TEST CONDITIONS
		MIN	TYP	MAX	MIN	TYP	MAX		
1	BV _{DSS} Drain-Source Breakdown Voltage	60	100		60	100		V	I _D =100μA, V _{GS} = 0
2	V _{GS(th)} Gate-Source	0.8	1.9	2.5	0.6	1.9	2.5	V	I _D = 1.0mA, V _{DS} = V _{GS}
3	I _{GSS} Gate-Body Leakage Current		±1.0	±100		±1.0	±100	nA	V _{GS} = ±30V, V _{DS} = 0
4	I _{DSS} Drain-Source OFF Leakage Current		0.1	10		0.1	10	μA	V _{DS} = 48V, V _{GS} = 0
5			5.0	500		5.0	500		T _A = 125°C
6	I _{D(on)} ON Drain Current	1.0	2.2		1.0	2.2		A	V _{DS} = 10V, V _{GS} = 10V (Note 1)
7	V _{DS(on)} Drain-Source ON Voltage		0.9	1.5		0.9	1.5	V	V _{GS} = 5V, I _D = 0.2A (Note 1)
8			1.5	2.5		1.5	3.75		V _{GS} = 10V, I _D = 0.5A (Note 1)
9			4.5	7.5		4.5	7.5		V _{GS} = 5V, I _D = 0.2A (Note 1)
10	r _{DS(on)} Drain-Source ON Resistance		3.0	5.0		3.0	7.5	ohms	V _{GS} = 10V, I _D = 0.5A (Note 1)
11			4.7	9.0		4.7	13.5		T _A = +125°C
12	g _{fs} Common-Source Forward Transcond.	100	400		100	400		mmhos	V _{DS} = 10V, I _D = 0.5A f = 1KHz (Note 1)
13	C _{iss} Common-Source Input Capacitance		80	100		80	100	pF	V _{DS} = 15V, V _{GS} = 0 f = 1MHz
14	C _{rss} Common-Source Reverse Transfer Capacitance		1.3	5.0		1.3	5.0		
15	C _{OSS} Common-Source Output Capacitance		10.5	25		10.5	25		
16	t _{on} Turn-On Time		5.0	10		5.0	10	nSec	V _{DD} = 15V, V _{G(on)} = 10V
17	t _{off} Turn-Off Time		6.0	10		6.0	10		R _G = 25Ω, R _L = 25Ω

Note 1: Pulse Test 80μ Sec, 1% Duty Cycle